



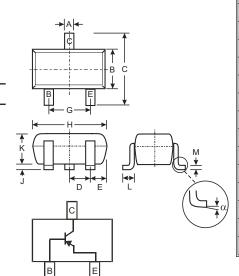
### PNP SMALL SIGNAL SURFACE MOUNT TRANSISTOR

### **Features**

- Epitaxial Planar Die Construction
- Complementary NPN Type Available (MMST4401)
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

### **Mechanical Data**

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Marking (See Page 2): K3T
- Ordering & Date Code Information: See Page 2
- Weight: 0.006 grams (approximate)



SOT-323							
Dim	Min	Max					
Α	0.25	0.40					
В	1.15	1.35					
С	2.00	2.20					
D	0.65 Nominal						
E	0.30	0.40					
G	1.20	1.40					
Н	1.80	2.20					
J	0.0	0.10					
K	0.90	1.00					
L	0.25	0.40					
М	0.10	0.18					
α	0°	8°					
All Dimensions in mm							

#### **Maximum Ratings** @ $T_A = 25$ °C unless otherwise specified

Characteristic	Symbol	MMST4403	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-40	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-40	V
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	V
Collector Current - Continuous (Note 1)	Ic	-600	mA
Power Dissipation (Note 1)	P <sub>d</sub>	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	$R_{ heta JA}$	625	K/W
Operating and Storage and Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-55 to +150	°C

Note: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

- 2. No purposefully added lead.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com./products/lead\_free/index.php.
- 4. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



## Electrical Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 5)							
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	-40	_	V	$I_C = -100 \mu A, I_E = 0$		
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	-40	_	V	I <sub>C</sub> = -1.0mA, I <sub>B</sub> = 0		
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	-5.0	_	V	$I_E = -100 \mu A, I_C = 0$		
Collector Cutoff Current	I <sub>CEX</sub>	_	-100	nA	$V_{CE} = -35V, V_{EB(OFF)} = -0.4V$		
Base Cutoff Current	I <sub>BL</sub>	_	-100	nA	$V_{CE} = -35V, V_{EB(OFF)} = -0.4V$		
ON CHARACTERISTICS (Note 5)							
DC Current Gain	h <sub>FE</sub>	30 60 100 100 20	300	_	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>	_	-0.40 -0.75	V	I <sub>C</sub> = -150mA, I <sub>B</sub> = -15mA I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA		
Base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>	-0.75 —	-0.95 -1.30	V	I <sub>C</sub> = -150mA, I <sub>B</sub> = -15mA I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA		
SMALL SIGNAL CHARACTERISTICS	•			•			
Output Capacitance	C <sub>cb</sub>	_	8.5	pF	$V_{CB} = -10V$ , $f = 1.0MHz$ , $I_E = 0$		
Input Capacitance	C <sub>eb</sub>	_	30	pF	$V_{EB} = -0.5V$ , $f = 1.0MHz$ , $I_C = 0$		
Input Impedance	h <sub>ie</sub>	1.5	15	kΩ			
Voltage Feedback Ratio	h <sub>re</sub>	0.1	8.0	x 10 <sup>-4</sup>	$V_{CE} = -10V, I_{C} = -1.0mA,$		
Small Signal Current Gain	h <sub>fe</sub>	60	500	_	f = 1.0kHz		
Output Admittance	h <sub>oe</sub>	1.0	100	μS			
Current Gain-Bandwidth Product	f <sub>T</sub>	200	_	MHz	$V_{CE} = -10V, I_{C} = -20mA, f = 100MHz$		
SWITCHING CHARACTERISTICS							
Delay Time	t <sub>d</sub>		15	ns	V <sub>CC</sub> = -30V, I <sub>C</sub> = -150mA,		
Rise Time	t <sub>r</sub>	_	20	ns	$V_{BE(off)} = -2.0V, I_{B1} = -15mA$		
Storage Time	t <sub>s</sub>		225	ns	V <sub>CC</sub> = -30V, I <sub>C</sub> = -150mA,		
Fall Time	t <sub>f</sub>	_	30	ns	$I_{B1} = I_{B2} = -15\text{mA}$		

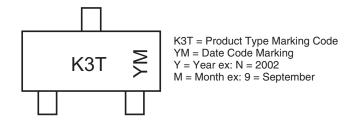
# Ordering Information (Note 4 & 6)

Device	Packaging	Shipping			
MMST4403-7-F	SOT-323	3000/Tape & Reel			

Notes: 4. Product manufactured with Date Code 0609 (week 9, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0609 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

- 5. Short duration test pulse used to minimize self-heating effect.
- 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

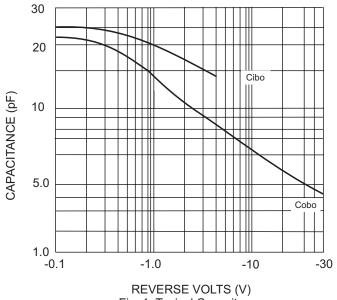
# **Marking Information**



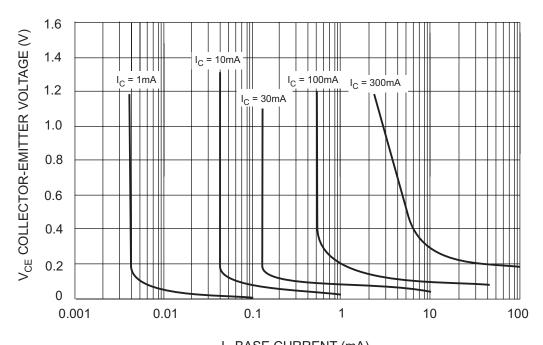
### Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009
Code	J	K	L	М	N	Р	R	S	Т	U	V	W
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D





REVERSE VOLTS (V) Fig. 1 Typical Capacitance



 $\rm I_B$  BASE CURRENT (mA) Fig. 2 Typical Collector Saturation Region



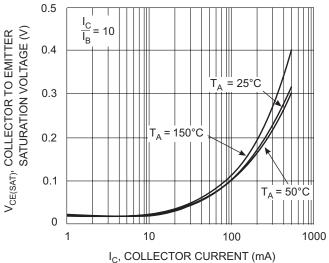
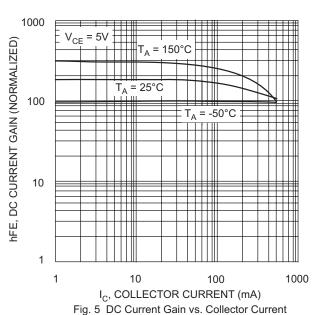
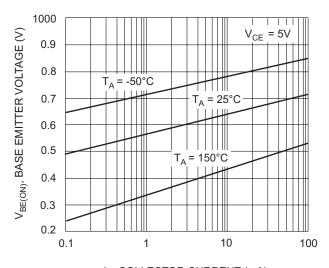


Fig. 3 Collector Emitter Saturation Voltage vs. Collector Current



350 P<sub>D</sub>, POWER DISSIPATION (mW) 300 250 200 150 100 50 0 0 25 50 75 100 125 150 175 200

T<sub>A</sub>, AMBIENT TEMPERATURE (°C) Fig. 7, Max Power Dissipation vs Ambient Temperature



I<sub>C</sub>, COLLECTOR CURRENT (mA) Fig. 4 Base-Emitter Voltage vs. Collector Current

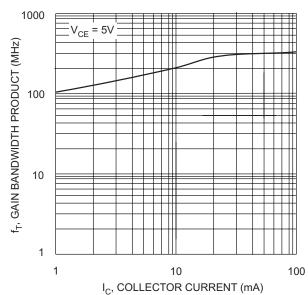


Fig. 6 Gain Bandwidth Product vs. Collector Current



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